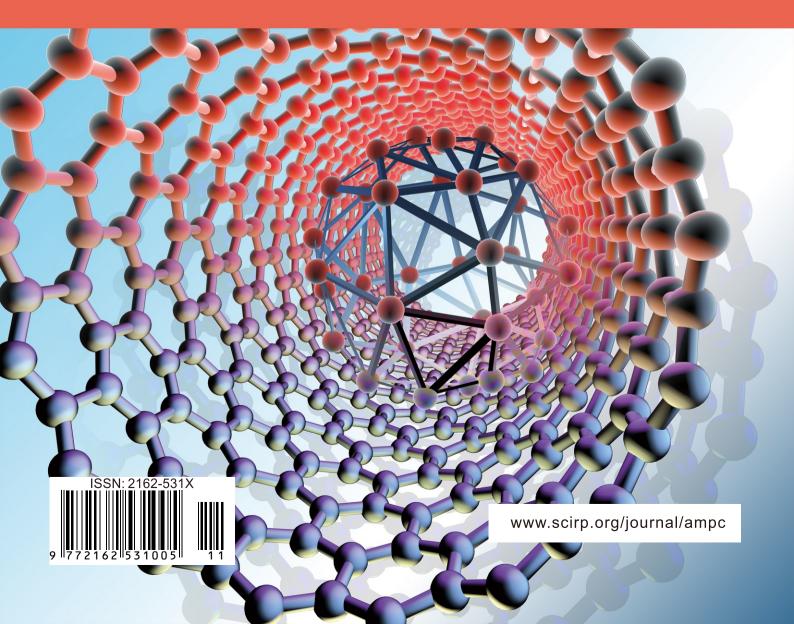


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ISSN: 2162-531X (Print) ISSN: 2162-5328 (Online) http://www.scirp.org/journal/ampc

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